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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

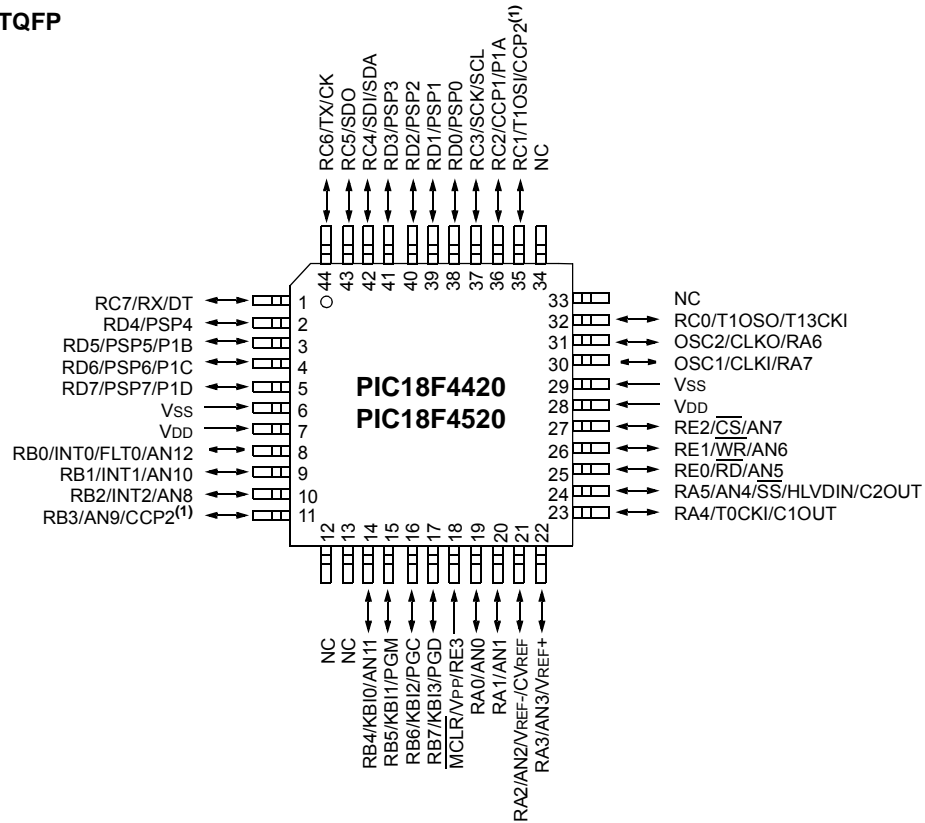
#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	25MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic18f2520-e-so">https://www.e-xfl.com/product-detail/microchip-technology/pic18f2520-e-so</a>

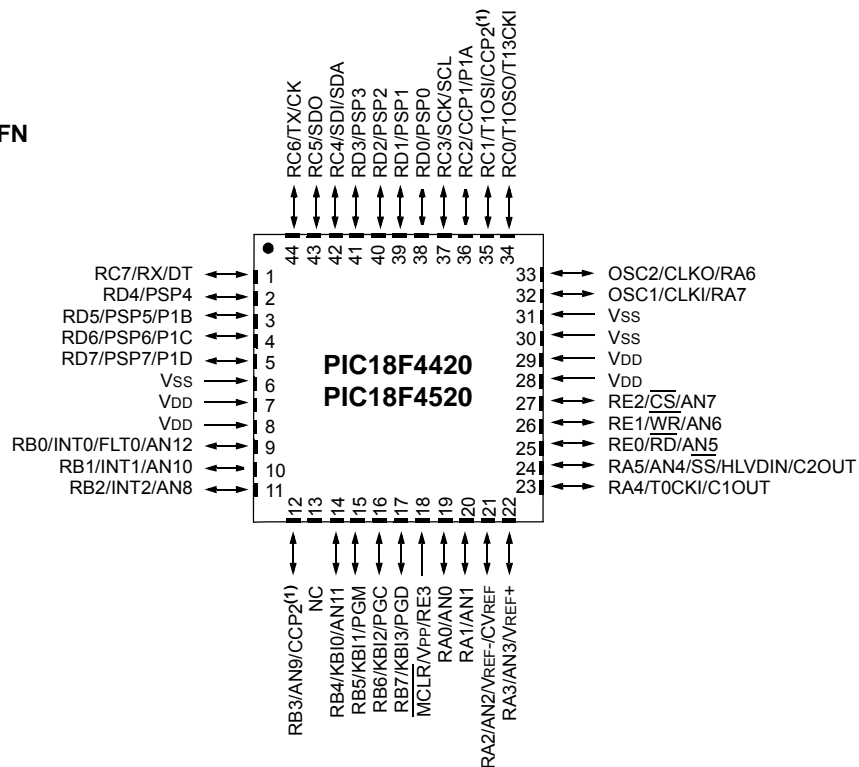
# PIC18F2420/2520/4420/4520

## Pin Diagrams (Cont.'d)

44-pin TQFP



44-pin QFN



**Note 1:** RB3 is the alternate pin for CCP2 multiplexing.

# PIC18F2420/2520/4420/4520

**TABLE 1-2: PIC18F2420/2520 PINOUT I/O DESCRIPTIONS (CONTINUED)**

Pin Name	Pin Number		Pin Type	Buffer Type	Description
	SPDIP, SOIC	QFN			
RC0/T1OSO/T13CKI	11	8	I/O	ST	PORTC is a bidirectional I/O port.
RC0			O	—	Digital I/O.
T1OSO			I	ST	Timer1 oscillator output.
T13CKI			I	ST	Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2	12	9	I/O	ST	Digital I/O.
RC1			I	Analog	Timer1 oscillator input.
T1OSI			I/O	ST	Capture 2 input/Compare 2 output/PWM2 output.
CCP2 <sup>(2)</sup>			I/O	ST	
RC2/CCP1	13	10	I/O	ST	Digital I/O.
RC2			I/O	ST	Capture 1 input/Compare 1 output/PWM1 output.
CCP1			I/O	ST	
RC3/SCK/SCL	14	11	I/O	ST	Digital I/O.
RC3			I/O	ST	Synchronous serial clock input/output for SPI mode.
SCK			I/O	ST	Synchronous serial clock input/output for I <sup>2</sup> C™ mode.
SCL			I/O	ST	
RC4/SDI/SDA	15	12	I/O	ST	Digital I/O.
RC4			I	ST	SPI data in.
SDI			I/O	ST	I <sup>2</sup> C data I/O.
SDA			I/O	ST	
RC5/SDO	16	13	I/O	ST	Digital I/O.
RC5			O	—	SPI data out.
SDO			O	—	
RC6/TX/CK	17	14	I/O	ST	Digital I/O.
RC6			O	—	EUSART asynchronous transmit.
TX			I/O	ST	EUSART synchronous clock (see related RX/DT).
CK			I/O	ST	
RC7/RX/DT	18	15	I/O	ST	Digital I/O.
RC7			I	ST	EUSART asynchronous receive.
RX			I/O	ST	EUSART synchronous data (see related TX/CK).
DT			I/O	ST	
RE3	—	—	—	—	See MCLR/VPP/RE3 pin.
Vss	8, 19	5, 16	P	—	Ground reference for logic and I/O pins.
VDD	20	17	P	—	Positive supply for logic and I/O pins.

**Legend:** TTL = TTL compatible input      CMOS = CMOS compatible input or output  
ST = Schmitt Trigger input with CMOS levels      I = Input  
O = Output      P = Power

**Note 1:** Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

**2:** Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

# PIC18F2420/2520/4420/4520

**TABLE 1-3: PIC18F4420/4520 PINOUT I/O DESCRIPTIONS (CONTINUED)**

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
RA0/AN0 RA0 AN0	2	19	19	I/O I	TTL Analog	PORTA is a bidirectional I/O port.  Digital I/O. Analog input 0.
RA1/AN1 RA1 AN1	3	20	20	I/O I	TTL Analog	Digital I/O. Analog input 1.
RA2/AN2/VREF-/CVREF RA2 AN2 VREF- CVREF	4	21	21	I/O I I O	TTL Analog Analog Analog	Digital I/O. Analog input 2. A/D reference voltage (low) input. Comparator reference voltage output.
RA3/AN3/VREF+ RA3 AN3 VREF+	5	22	22	I/O I I	TTL Analog Analog	Digital I/O. Analog input 3. A/D reference voltage (high) input.
RA4/T0CKI/C1OUT RA4 T0CKI C1OUT	6	23	23	I/O I O	ST ST —	Digital I/O. Timer0 external clock input. Comparator 1 output.
RA5/AN4/ $\overline{SS}$ /HLVDIN/ C2OUT RA5 AN4 $\overline{SS}$ HLVDIN C2OUT	7	24	24	I/O I I I O	TTL Analog TTL Analog —	Digital I/O. Analog input 4. SPI slave select input. High/Low-Voltage Detect input. Comparator 2 output.
RA6						See the OSC2/CLKO/RA6 pin.
RA7						See the OSC1/CLKI/RA7 pin.

**Legend:** TTL = TTL compatible input      CMOS = CMOS compatible input or output  
ST = Schmitt Trigger input with CMOS levels      I = Input  
O = Output      P = Power

**Note 1:** Default assignment for CCP2 when Configuration bit, CCP2MX, is set.  
**2:** Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

# PIC18F2420/2520/4420/4520

## 7.6 Operation During Code-Protect

Data EEPROM memory has its own code-protect bits in Configuration Words. External read and write operations are disabled if code protection is enabled.

The microcontroller itself can both read and write to the internal data EEPROM, regardless of the state of the code-protect Configuration bit. Refer to **Section 23.0 “Special Features of the CPU”** for additional information.

## 7.7 Protection Against Spurious Write

There are conditions when the user may not want to write to the data EEPROM memory. To protect against spurious EEPROM writes, various mechanisms have been implemented. On power-up, the WREN bit is cleared. In addition, writes to the EEPROM are blocked during the Power-up Timer period (TPWRT, parameter 33).

The write initiate sequence and the WREN bit together help prevent an accidental write during brown-out, power glitch or software malfunction.

## 7.8 Using the Data EEPROM

The data EEPROM is a high-endurance, byte addressable array that has been optimized for the storage of frequently changing information (e.g., program variables or other data that are updated often). Frequently changing values will typically be updated more often than specification D124. If this is not the case, an array refresh must be performed. For this reason, variables that change infrequently (such as constants, IDs, calibration, etc.) should be stored in Flash program memory.

A simple data EEPROM refresh routine is shown in Example 7-3.

**Note:** If data EEPROM is only used to store constants and/or data that changes rarely, an array refresh is likely not required. See specification D124.

### EXAMPLE 7-3: DATA EEPROM REFRESH ROUTINE

```
CLRF    EEADR      ; Start at address 0
BCF     EECON1, CFGS ; Set for memory
BCF     EECON1, EEPGD ; Set for Data EEPROM
BCF     INTCON, GIE  ; Disable interrupts
BSF     EECON1, WREN  ; Enable writes
Loop:   BSF     EECON1, RD      ; Loop to refresh array
        MOVLW  55h             ; Read current address
        MOVWF  EECON2           ; Write 55h
        MOVLW  0AAh            ;
        MOVWF  EECON2           ; Write 0AAh
        BSF     EECON1, WR      ; Set WR bit to begin write
        BTFSC  EECON1, WR      ; Wait for write to complete
        BRA     $-2
        INCF    EEADR, F        ; Increment address
        BRA     LOOP           ; Not zero, do it again

        BCF     EECON1, WREN    ; Disable writes
        BSF     INTCON, GIE     ; Enable interrupts
```

# PIC18F2420/2520/4420/4520

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NOTES:

# PIC18F2420/2520/4420/4520

## 12.1 Timer1 Operation

Timer1 can operate in one of these modes:

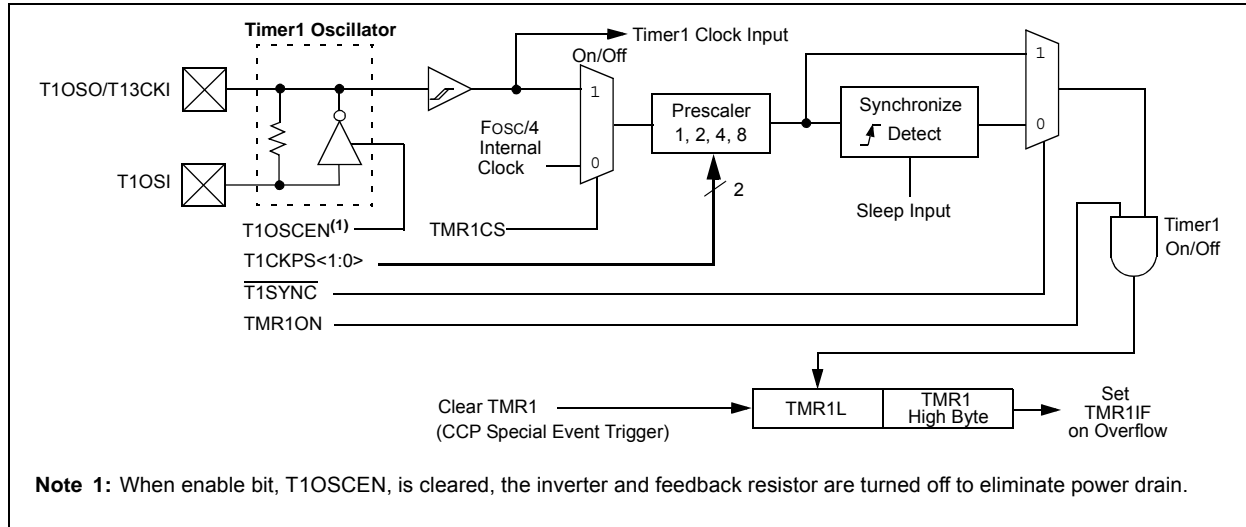
- Timer
- Synchronous Counter
- Asynchronous Counter

The operating mode is determined by the clock select bit, TMR1CS (T1CON<1>). When TMR1CS is cleared (= 0), Timer1 increments on every internal instruction

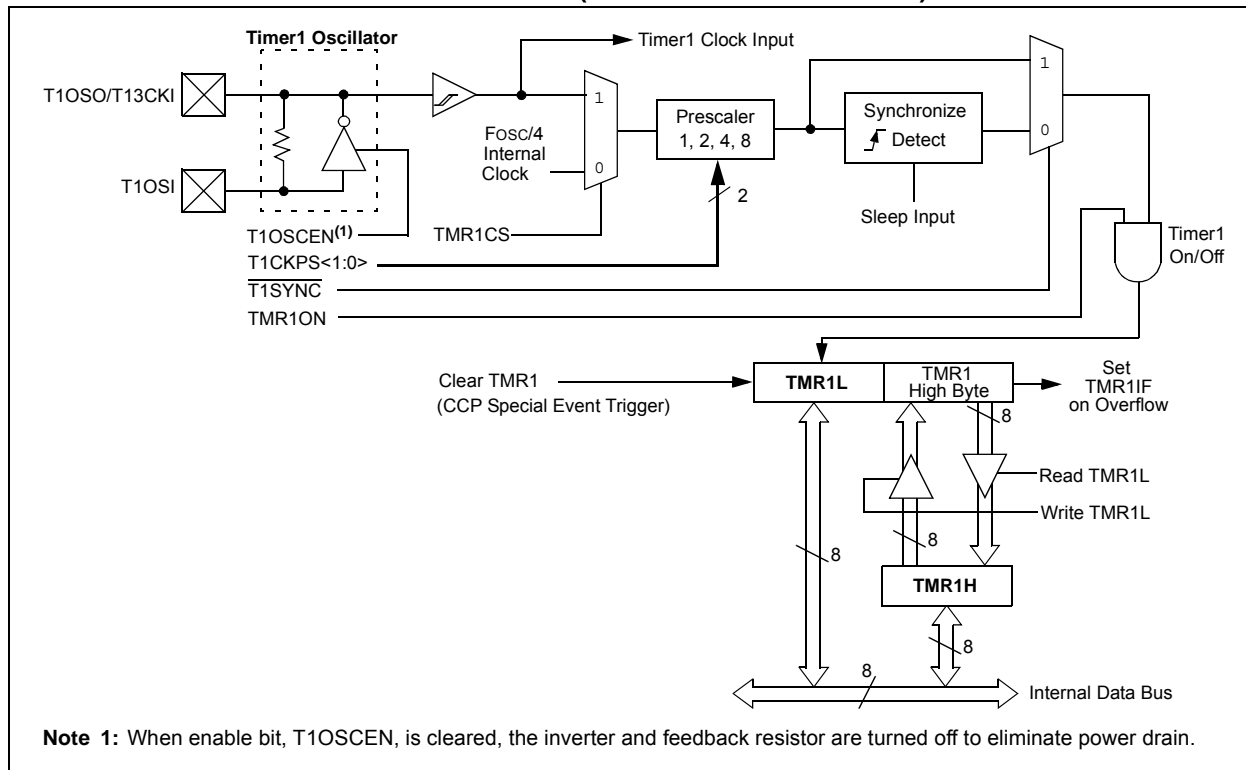
cycle ( $F_{osc}/4$ ). When the bit is set, Timer1 increments on every rising edge of the Timer1 external clock input or the Timer1 oscillator, if enabled.

When Timer1 is enabled, the RC1/T1OSI and RC0/T1OSO/T13CKI pins become inputs. This means the values of TRISC<1:0> are ignored and the pins are read as '0'.

**FIGURE 12-1: TIMER1 BLOCK DIAGRAM**



**FIGURE 12-2: TIMER1 BLOCK DIAGRAM (16-BIT READ/WRITE MODE)**



# PIC18F2420/2520/4420/4520

**REGISTER 17-5: SSPCON2: MSSP CONTROL REGISTER 2 (I<sup>2</sup>C™ MODE)**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT <sup>(2)</sup>	ACKEN <sup>(1)</sup>	RCEN <sup>(1)</sup>	PEN <sup>(1)</sup>	RSEN <sup>(1)</sup>	SEN <sup>(1)</sup>
bit 7							bit 0

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
 -n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

- bit 7            **GCEN:** General Call Enable bit (Slave mode only)  
                   1 = Enables interrupt when a general call address (0000h) is received in the SSPSR  
                   0 = General call address disabled.
- bit 6            **ACKSTAT:** Acknowledge Status bit (Master Transmit mode only)  
                   1 = Acknowledge was not received from slave  
                   0 = Acknowledge was received from slave
- bit 5            **ACKDT:** Acknowledge Data bit (Master Receive mode only)<sup>(2)</sup>  
                   1 = Not Acknowledge  
                   0 = Acknowledge
- bit 4            **ACKEN:** Acknowledge Sequence Enable bit (Master Receive mode only)<sup>(1)</sup>  
                   1 = Initiates Acknowledge sequence on SDA and SCL pins and transmit ACKDT data bit. Automatically cleared by hardware.  
                   0 = Acknowledge sequence Idle
- bit 3            **RCEN:** Receive Enable bit (Master mode only)<sup>(1)</sup>  
                   1 = Enables Receive mode for I<sup>2</sup>C  
                   0 = Receive Idle
- bit 2            **PEN:** Stop Condition Enable bit (Master mode only)<sup>(1)</sup>  
                   1 = Initiates Stop condition on SDA and SCL pins. Automatically cleared by hardware.  
                   0 = Stop condition Idle
- bit 1            **RSEN:** Repeated Start Condition Enable bit (Master mode only)<sup>(1)</sup>  
                   1 = Initiates Repeated Start condition on SDA and SCL pins. Automatically cleared by hardware.  
                   0 = Repeated Start condition Idle
- bit 0            **SEN:** Start Condition Enable/Stretch Enable bit<sup>(1)</sup>  
                   In Master mode:  
                   1 = Initiates Start condition on SDA and SCL pins. Automatically cleared by hardware.  
                   0 = Start condition Idle  
                   In Slave mode:  
                   1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)  
                   0 = Clock stretching is disabled

**Note 1:** For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I<sup>2</sup>C module is not in the Idle mode, these bits may not be set (no spooling) and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

**2:** Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.



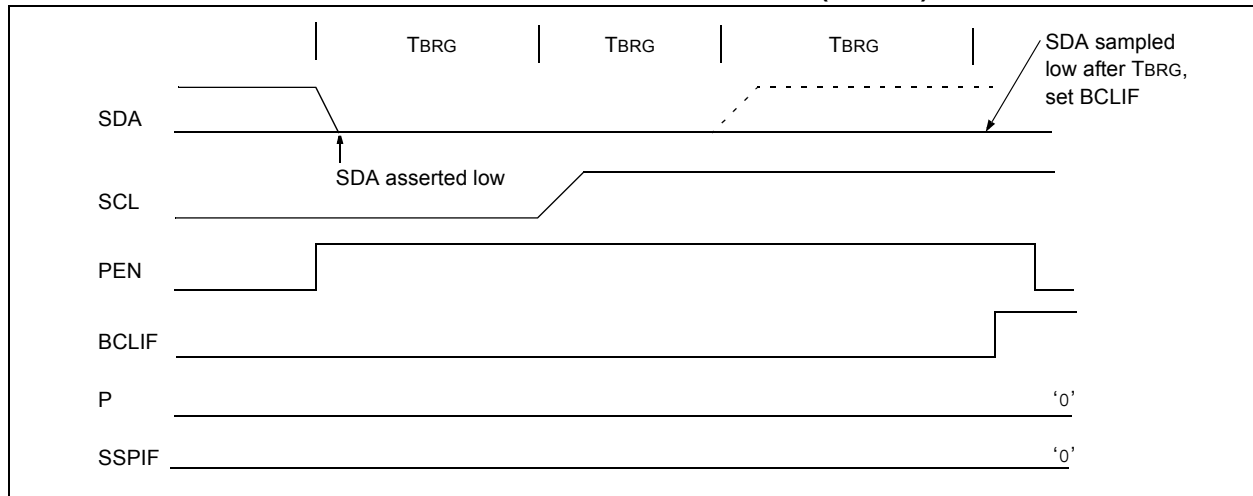
## 17.4.17.3 Bus Collision During a Stop Condition

Bus collision occurs during a Stop condition if:

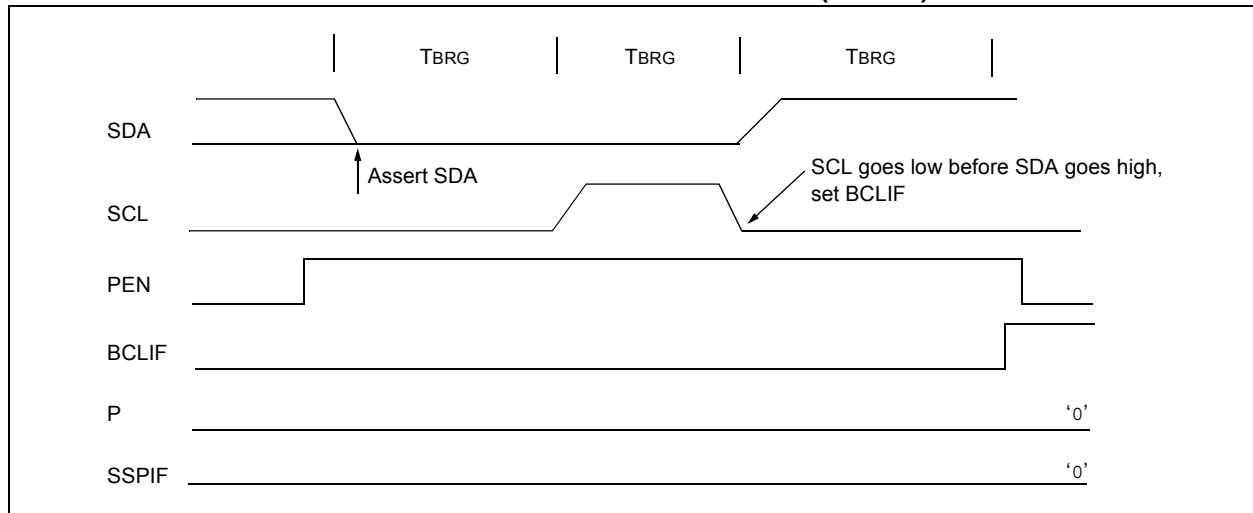
- After the SDA pin has been deasserted and allowed to float high, SDA is sampled low after the BRG has timed out.
- After the SCL pin is deasserted, SCL is sampled low before SDA goes high.

The Stop condition begins with SDA asserted low. When SDA is sampled low, the SCL pin is allowed to float. When the pin is sampled high (clock arbitration), the Baud Rate Generator is loaded with SSPADD<6:0> and counts down to 0. After the BRG times out, SDA is sampled. If SDA is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 17-31). If the SCL pin is sampled low before SDA is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 17-32).

**FIGURE 17-31: BUS COLLISION DURING A STOP CONDITION (CASE 1)**

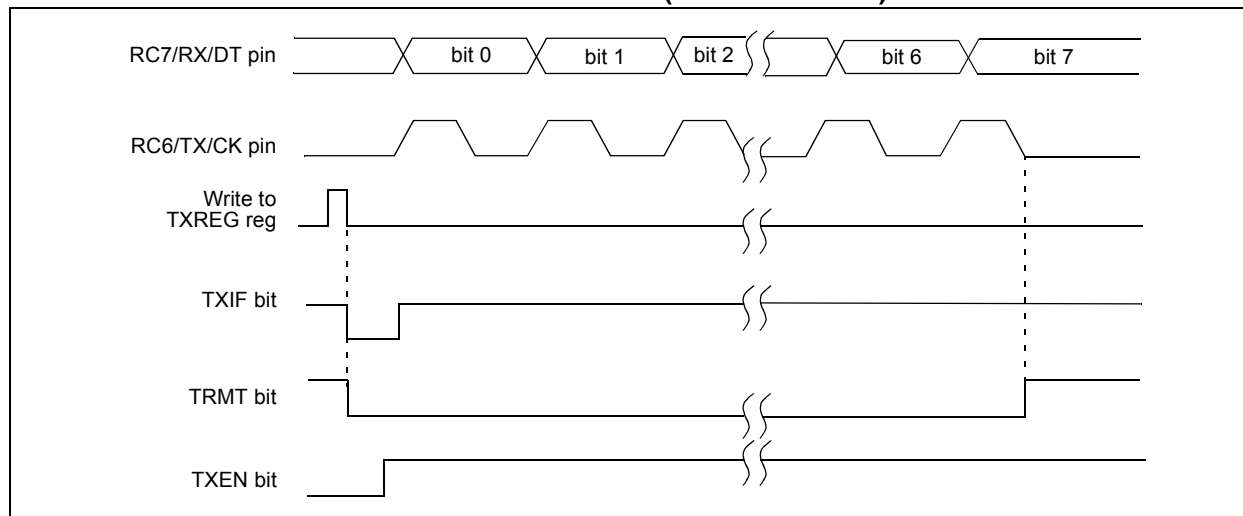


**FIGURE 17-32: BUS COLLISION DURING A STOP CONDITION (CASE 2)**



# PIC18F2420/2520/4420/4520

**FIGURE 18-12: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)**



**TABLE 18-7: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION**

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF <sup>(1)</sup>	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	52
PIE1	PSPIE <sup>(1)</sup>	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	52
IPR1	PSPIP <sup>(1)</sup>	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	52
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	51
TXREG	EUSART Transmit Register								51
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	51
BAUDCON	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	51
SPBRGH	EUSART Baud Rate Generator Register High Byte								51
SPBRG	EUSART Baud Rate Generator Register Low Byte								51

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

**Note 1:** Reserved in 28-pin devices; always maintain these bits clear.

## 19.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) Converter module has 10 inputs for the 28-pin devices and 13 for the 40/44-pin devices. This module allows conversion of an analog input signal to a corresponding 10-bit digital number.

The module has five registers:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)

The ADCON0 register, shown in Register 19-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 19-2, configures the functions of the port pins. The ADCON2 register, shown in Register 19-3, configures the A/D clock source, programmed acquisition time and justification.

**REGISTER 19-1: ADCON0: A/D CONTROL REGISTER 0**

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON
bit 7							bit 0

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-6	<b>Unimplemented:</b> Read as '0'
bit 5-2	<b>CHS&lt;3:0&gt;:</b> Analog Channel Select bits
	0000 = Channel 0 (AN0)
	0001 = Channel 1 (AN1)
	0010 = Channel 2 (AN2)
	0011 = Channel 3 (AN3)
	0100 = Channel 4 (AN4)
	0101 = Channel 5 (AN5) <sup>(1,2)</sup>
	0110 = Channel 6 (AN6) <sup>(1,2)</sup>
	0111 = Channel 7 (AN7) <sup>(1,2)</sup>
	1000 = Channel 8 (AN8)
	1001 = Channel 9 (AN9)
	1010 = Channel 10 (AN10)
	1011 = Channel 11 (AN11)
	1100 = Channel 12 (AN12)
	1101 = Unimplemented <sup>(2)</sup>
	1110 = Unimplemented <sup>(2)</sup>
	1111 = Unimplemented <sup>(2)</sup>
bit 1	<b>GO/DONE:</b> A/D Conversion Status bit
	<u>When ADON = 1:</u>
	1 = A/D conversion in progress
	0 = A/D Idle
bit 0	<b>ADON:</b> A/D On bit
	1 = A/D Converter module is enabled
	0 = A/D Converter module is disabled

**Note 1:** These channels are not implemented on 28-pin devices.

**2:** Performing a conversion on unimplemented channels will return a floating input measurement.

## 22.2 HLVD Setup

The following steps are needed to set up the HLVD module:

1. Write the value to the HLVDL<3:0> bits that selects the desired HLVD trip point.
2. Set the VDIRMAG bit to detect high voltage (VDIRMAG = 1) or low voltage (VDIRMAG = 0).
3. Enable the HLVD module by setting the HLVDEN bit.
4. Clear the HLVD interrupt flag (PIR2<2>), which may have been set from a previous interrupt.
5. Enable the HLVD interrupt, if interrupts are desired, by setting the HLVDIE and GIE bits (PIE2<2> and INTCON<7>). An interrupt will not be generated until the IRVST bit is set.

## 22.3 Current Consumption

When the module is enabled, the HLVD comparator and voltage divider are enabled and will consume static current. The total current consumption, when enabled, is specified in electrical specification parameter D022B.

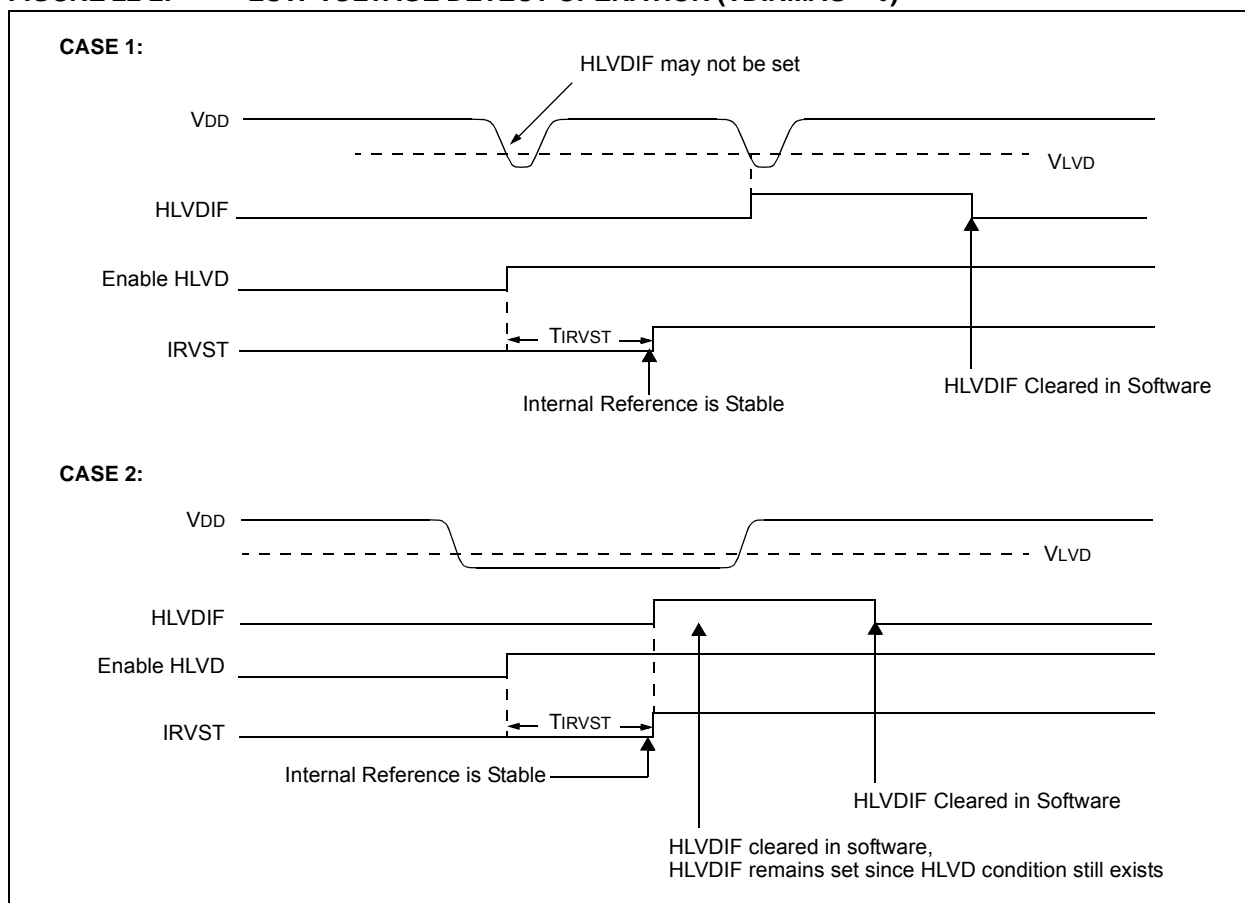
Depending on the application, the HLVD module does not need to be operating constantly. To decrease the current requirements, the HLVD circuitry may only need to be enabled for short periods where the voltage is checked. After doing the check, the HLVD module may be disabled.

## 22.4 HLVD Start-up Time

The internal reference voltage of the HLVD module, specified in electrical specification parameter D420, may be used by other internal circuitry, such as the programmable Brown-out Reset. If the HLVD or other circuits using the voltage reference are disabled to lower the device's current consumption, the reference voltage circuit will require time to become stable before a low or high-voltage condition can be reliably detected. This start-up time, T<sub>IRVST</sub>, is an interval that is independent of device clock speed. It is specified in electrical specification parameter 36.

The HLVD interrupt flag is not enabled until T<sub>IRVST</sub> has expired and a stable reference voltage is reached. For this reason, brief excursions beyond the set point may not be detected during this interval (refer to Figure 22-2 or Figure 22-3).

**FIGURE 22-2: LOW-VOLTAGE DETECT OPERATION (VDIRMAG = 0)**



# PIC18F2420/2520/4420/4520

## REGISTER 23-4: CONFIG3H: CONFIGURATION REGISTER 3 HIGH (BYTE ADDRESS 300005h)

R/P-1	U-0	U-0	U-0	U-0	R/P-0	R/P-1	R/P-1
MCLRE	—	—	—	—	LPT1OSC	PBADEN	CCP2MX
bit 7							bit 0

### Legend:

R = Readable bit

P = Programmable bit

U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed

u = Unchanged from programmed state

- bit 7 **MCLRE:**  $\overline{\text{MCLR}}$  Pin Enable bit  
 1 =  $\overline{\text{MCLR}}$  pin enabled; RE3 input pin disabled  
 0 = RE3 input pin enabled;  $\overline{\text{MCLR}}$  disabled
- bit 6-3 **Unimplemented:** Read as '0'
- bit 2 **LPT1OSC:** Low-Power Timer1 Oscillator Enable bit  
 1 = Timer1 configured for low-power operation  
 0 = Timer1 configured for higher power operation
- bit 1 **PBADEN:** PORTB A/D Enable bit  
 (Affects ADCON1 Reset state. ADCON1 controls PORTB<4:0> pin configuration.)  
 1 = PORTB<4:0> pins are configured as analog input channels on Reset  
 0 = PORTB<4:0> pins are configured as digital I/O on Reset
- bit 0 **CCP2MX:** CCP2 MUX bit  
 1 = CCP2 input/output is multiplexed with RC1  
 0 = CCP2 input/output is multiplexed with RB3

## REGISTER 23-5: CONFIG4L: CONFIGURATION REGISTER 4 LOW (BYTE ADDRESS 300006h)

R/P-1	R/P-0	U-0	U-0	U-0	R/P-1	U-0	R/P-1
$\overline{\text{DEBUG}}$	XINST	—	—	—	LVP	—	STVREN
bit 7							bit 0

### Legend:

R = Readable bit

P = Programmable bit

U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed

u = Unchanged from programmed state

- bit 7  **$\overline{\text{DEBUG}}$ :** Background Debugger Enable bit  
 1 = Background debugger disabled, RB6 and RB7 configured as general purpose I/O pins  
 0 = Background debugger enabled, RB6 and RB7 are dedicated to In-Circuit Debug
- bit 6 **XINST:** Extended Instruction Set Enable bit  
 1 = Instruction set extension and Indexed Addressing mode enabled  
 0 = Instruction set extension and Indexed Addressing mode disabled (Legacy mode)
- bit 5-3 **Unimplemented:** Read as '0'
- bit 2 **LVP:** Single-Supply ICSP™ Enable bit  
 1 = Single-Supply ICSP enabled  
 0 = Single-Supply ICSP disabled
- bit 1 **Unimplemented:** Read as '0'
- bit 0 **STVREN:** Stack Full/Underflow Reset Enable bit  
 1 = Stack full/underflow will cause Reset  
 0 = Stack full/underflow will not cause Reset

# PIC18F2420/2520/4420/4520

## BRA Unconditional Branch

Syntax: BRA n

Operands:  $-1024 \leq n \leq 1023$

Operation:  $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 

1101	0nnn	nnnn	nnnn
------	------	------	------

Description: Add the 2's complement number, '2n', to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be  $PC + 2 + 2n$ . This instruction is a two-cycle instruction.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

Example:                    HERE            BRA    Jump

Before Instruction  
PC = address (HERE)  
After Instruction  
PC = address (Jump)

## BSF Bit Set f

Syntax: BSF f, b {,a}

Operands:  $0 \leq f \leq 255$

$0 \leq b \leq 7$

$a \in [0,1]$

Operation:  $1 \rightarrow f[b]$

Status Affected: None

Encoding: 

1000	bbba	ffff	ffff
------	------	------	------

Description: Bit 'b' in register 'f' is set.  
If 'a' is '0', the Access Bank is selected.  
If 'a' is '1', the BSR is used to select the GPR bank (default).  
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever  $f \leq 95$  (5Fh). See **Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example:                    BSF            FLAG\_REG, 7, 1

Before Instruction  
FLAG\_REG = 0Ah  
After Instruction  
FLAG\_REG = 8Ah

# PIC18F2420/2520/4420/4520

DECFSZ		Decrement f, Skip if 0							
Syntax:	DECFSZ f {,d {,a}}								
Operands:	$0 \leq f \leq 255$ $d \in [0,1]$ $a \in [0,1]$								
Operation:	$(f) - 1 \rightarrow \text{dest}$ , skip if result = 0								
Status Affected:	None								
Encoding:	<table border="1"><tr><td>0010</td><td>11da</td><td>ffff</td><td>ffff</td></tr></table>					0010	11da	ffff	ffff
0010	11da	ffff	ffff						
Description:	<p>The contents of register 'f' are decremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). If the result is '0', the next instruction, which is already fetched, is discarded and a NOP is executed instead, making it a two-cycle instruction.</p> <p>If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).</p> <p>If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever <math>f \leq 95</math> (5Fh). See <b>Section 24.2.3 “Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode”</b> for details.</p>								
Words:	1								
Cycles:	1(2)								
	<b>Note:</b> 3 cycles if skip and followed by a 2-word instruction.								

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

**Example:**

```

HERE    DECFSZ  CNT, 1, 1
        GOTO    LOOP
        CONTINUE
  
```

Before Instruction

PC = Address (HERE)

After Instruction

CNT = CNT - 1

If CNT = 0;

PC = Address (CONTINUE)

If CNT  $\neq$  0;

PC = Address (HERE + 2)

DCFSNZ		Decrement f, Skip if Not 0							
Syntax:	DCFSNZ f {,d {,a}}								
Operands:	$0 \leq f \leq 255$ $d \in [0,1]$ $a \in [0,1]$								
Operation:	$(f) - 1 \rightarrow \text{dest}$ , skip if result $\neq 0$								
Status Affected:	None								
Encoding:	<table border="1"><tr><td>0100</td><td>11da</td><td>ffff</td><td>ffff</td></tr></table>					0100	11da	ffff	ffff
0100	11da	ffff	ffff						
Description:	<p>The contents of register 'f' are decremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). If the result is not '0', the next instruction, which is already fetched, is discarded and a NOP is executed instead, making it a two-cycle instruction.</p> <p>If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).</p> <p>If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever <math>f \leq 95</math> (5Fh). See <b>Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"</b> for details.</p>								
Words:	1								
Cycles:	1(2)								
	<b>Note:</b> 3 cycles if skip and followed by a 2-word instruction.								

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

**Example:**

```

HERE    DCFSNZ  TEMP, 1, 0
ZERO    :
NZERO   :
  
```

Before Instruction

TEMP = ?

After Instruction

TEMP = TEMP - 1,

If TEMP = 0;

PC = Address (ZERO)

If TEMP  $\neq$  0;

PC = Address (NZERO)

## 25.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
  - MPLAB® IDE Software
- Assemblers/Compilers/Linkers
  - MPASM™ Assembler
  - MPLAB C18 and MPLAB C30 C Compilers
  - MPLINK™ Object Linker/  
MPLIB™ Object Librarian
  - MPLAB ASM30 Assembler/Linker/Library
- Simulators
  - MPLAB SIM Software Simulator
- Emulators
  - MPLAB ICE 2000 In-Circuit Emulator
  - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debugger
  - MPLAB ICD 2
- Device Programmers
  - PICSTART® Plus Development Programmer
  - MPLAB PM3 Device Programmer
  - PICKit™ 2 Development Programmer
- Low-Cost Demonstration and Development Boards and Evaluation Kits

## 25.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit microcontroller market. The MPLAB IDE is a Windows® operating system-based application that contains:

- A single graphical interface to all debugging tools
  - Simulator
  - Programmer (sold separately)
  - Emulator (sold separately)
  - In-Circuit Debugger (sold separately)
- A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- High-level source code debugging
- Visual device initializer for easy register initialization
- Mouse over variable inspection
- Drag and drop variables from source to watch windows
- Extensive on-line help
- Integration of select third party tools, such as HI-TECH Software C Compilers and IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PIC MCU emulator and simulator tools (automatically updates all project information)
- Debug using:
  - Source files (assembly or C)
  - Mixed assembly and C
  - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.



# PIC18F2420/2520/4420/4520

## 26.3 DC Characteristics: PIC18F2420/2520/4420/4520 (Industrial) PIC18LF2420/2520/4420/4520 (Industrial)

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial			
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
D030 D030A D031 D031A D031B D032 D033 D033A D033B D034	$V_{IL}$	<b>Input Low Voltage</b> I/O Ports: with TTL Buffer with Schmitt Trigger Buffer RC3 and RC4 $\overline{\text{MCLR}}$ OSC1 OSC1 OSC1 T13CKI	$V_{SS}$ — $V_{SS}$ $V_{SS}$ $V_{SS}$ $V_{SS}$ $V_{SS}$ $V_{SS}$ $V_{SS}$ $V_{SS}$	$0.15 V_{DD}$ 0.8 $0.2 V_{DD}$ $0.3 V_{DD}$ 0.8 $0.2 V_{DD}$ $0.3 V_{DD}$ $0.2 V_{DD}$ 0.3 0.3	V V V V V V V V V V	$V_{DD} < 4.5\text{V}$ $4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$ $I^2\text{C}^{\text{TM}}$ enabled SMBus enabled HS, HSPLL modes RC, EC modes <sup>(1)</sup> XT, LP modes
D040 D040A D041 D041A D041B D042 D043 D043A D043B D043C D044	$V_{IH}$	<b>Input High Voltage</b> I/O Ports: with TTL Buffer with Schmitt Trigger Buffer RC3 and RC4 $\overline{\text{MCLR}}$ OSC1 OSC1 OSC1 OSC1 T13CKI	$0.25 V_{DD} + 0.8\text{V}$ 2.0 $0.8 V_{DD}$ $0.7 V_{DD}$ 2.1 $0.8 V_{DD}$ $0.7 V_{DD}$ $0.8 V_{DD}$ $0.9 V_{DD}$ 1.6 1.6	$V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$	V V V V V V V V V V V	$V_{DD} < 4.5\text{V}$ $4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$ $I^2\text{C}$ enabled SMBus enabled HS, HSPLL modes EC mode RC mode <sup>(1)</sup> XT, LP modes
D060  D061 D063	$I_{IL}$	<b>Input Leakage Current<sup>(2,3)</sup></b> I/O Ports $\overline{\text{MCLR}}$ OSC1	— — —	$\pm 200$ $\pm 50$ $\pm 1$ $\pm 1$	nA nA $\mu\text{A}$ $\mu\text{A}$	$V_{DD} < 5.5\text{V}$ , $V_{SS} \leq V_{PIN} \leq V_{DD}$ , Pin at high-impedance $V_{DD} < 3\text{V}$ , $V_{SS} \leq V_{PIN} \leq V_{DD}$ , Pin at high-impedance $V_{SS} \leq V_{PIN} \leq V_{DD}$ $V_{SS} \leq V_{PIN} \leq V_{DD}$
D070	IPU IPURB	<b>Weak Pull-up Current</b> PORTB Weak Pull-up Current	50	400	$\mu\text{A}$	$V_{DD} = 5\text{V}$ , $V_{PIN} = V_{SS}$

**Note 1:** In RC oscillator configuration, the OSC1/CLKI pin is a Schmitt Trigger input. It is not recommended that the PIC<sup>®</sup> device be driven with an external clock while in RC mode.

**2:** The leakage current on the  $\overline{\text{MCLR}}$  pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

**3:** Negative current is defined as current sourced by the pin.

# PIC18F2420/2520/4420/4520

## 26.4 AC (Timing) Characteristics

### 26.4.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created using one of the following formats:

1. TppS2ppS
2. TppS
3. TCC:ST (I<sup>2</sup>C specifications only)
4. Ts (I<sup>2</sup>C specifications only)

T		T	
F	Frequency	T	Time

Lowercase letters (pp) and their meanings:

pp			
cc	CCP1	osc	OSC1
ck	CLKO	rd	$\overline{RD}$
cs	$\overline{CS}$	rw	$\overline{RD}$ or $\overline{WR}$
di	SDI	sc	SCK
do	SDO	ss	$\overline{SS}$
dt	Data in	t0	T0CKI
io	I/O port	t1	T13CKI
mc	$\overline{MCLR}$	wr	$\overline{WR}$

Uppercase letters and their meanings:

S			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (High-impedance)	V	Valid
L	Low	Z	High-impedance
I <sup>2</sup> C only			
AA	output access	High	High
BUF	Bus free	Low	Low

TCC:ST (I<sup>2</sup>C specifications only)

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	Stop condition
STA	Start condition		

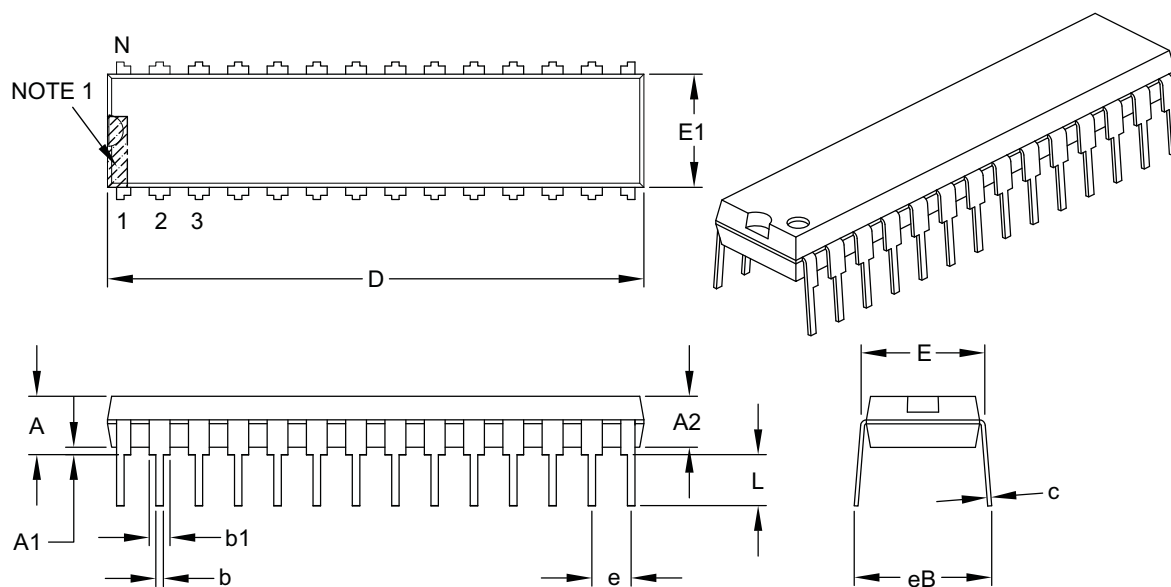
# PIC18F2420/2520/4420/4520

## 28.2 Package Details

The following sections give the technical details of the packages.

### 28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	.100 BSC		
Top to Seating Plane	A	—	—	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	—	—
Shoulder to Shoulder Width	E	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	—	—	.430

**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

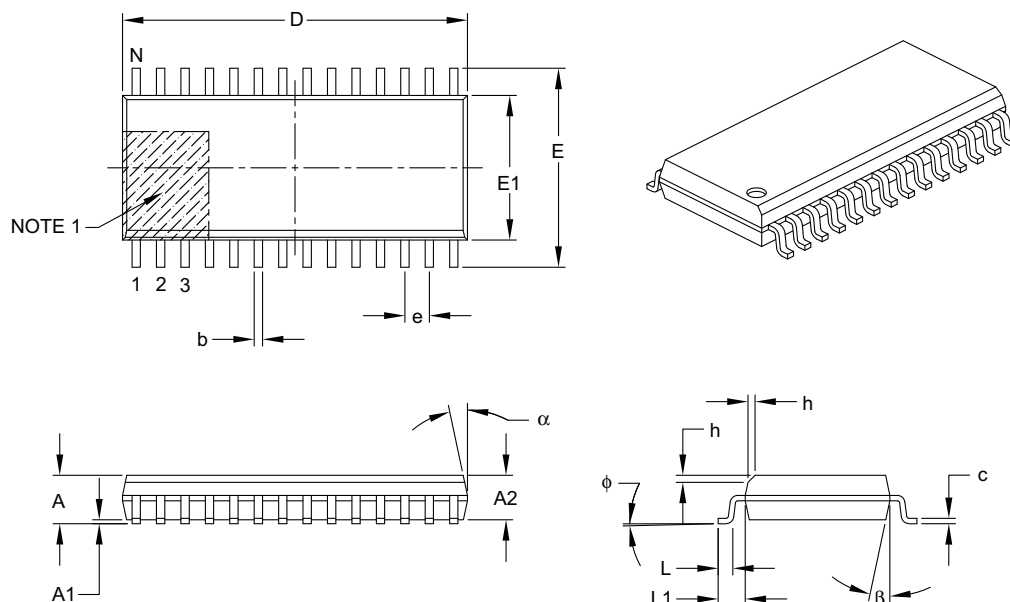
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

# PIC18F2420/2520/4420/4520

## 28-Lead Plastic Small Outline (SO) – Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	1.27 BSC		
Overall Height	A	–	–	2.65
Molded Package Thickness	A2	2.05	–	–
Standoff §	A1	0.10	–	0.30
Overall Width	E	10.30 BSC		
Molded Package Width	E1	7.50 BSC		
Overall Length	D	17.90 BSC		
Chamfer (optional)	h	0.25	–	0.75
Foot Length	L	0.40	–	1.27
Footprint	L1	1.40 REF		
Foot Angle Top	φ	0°	–	8°
Lead Thickness	c	0.18	–	0.33
Lead Width	b	0.31	–	0.51
Mold Draft Angle Top	α	5°	–	15°
Mold Draft Angle Bottom	β	5°	–	15°

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-052B

# PIC18F2420/2520/4420/4520

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Associated Registers .....	107	Program Counter .....	54
LATA Register .....	105	PCL, PCH and PCU Registers .....	54
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